

General Description

The MDI5N40 / MDD5N40 use advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

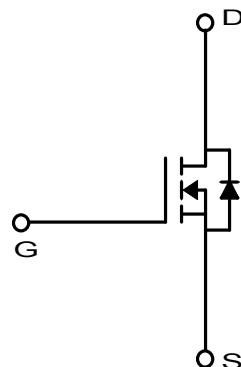
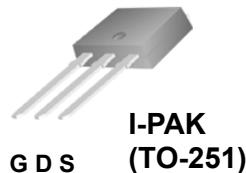
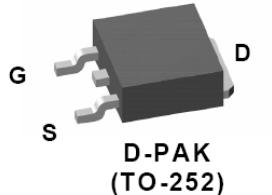
MDI5N40 is suitable device for SMPS, HID and general purpose applications.

Features

- $V_{DS} = 400V$
- $I_D = 3.4A$
- $R_{DS(ON)} \leq 1.6\Omega$
- $@V_{GS} = 10V$
- $@V_{GS} = 10V$

Applications

- Power Supply
- PFC
- Ballast



Absolute Maximum Ratings ($T_a = 25^\circ C$)

| Characteristics | Symbol | Rating | Unit |
|--------------------------------------------------|----------------|----------|--------------|
| Drain-Source Voltage | V_{DSS} | 400 | V |
| Gate-Source Voltage | V_{GSS} | ± 30 | V |
| Continuous Drain Current | I_D | 3.4 | A |
| | | 2.15 | A |
| Pulsed Drain Current ⁽¹⁾ | I_{DM} | 13.6 | A |
| Power Dissipation | P_D | 45 | W |
| | | 0.36 | $W/^\circ C$ |
| Peak Diode Recovery $dv/dt^{(3)}$ | Dv/dt | 4.5 | V/ns |
| Repetitive Pulse Avalanche Energy ⁽⁴⁾ | E_{AR} | 4.5 | mJ |
| Single Pulse Avalanche Energy ⁽⁴⁾ | E_{AS} | 170 | mJ |
| Junction and Storage Temperature Range | T_J, T_{stg} | -55~150 | $^\circ C$ |

Thermal Characteristics

| Characteristics | Symbol | Rating | Unit |
|--------------------------------------------------------|-----------------|--------|--------------|
| Thermal Resistance, Junction-to-Ambient ⁽¹⁾ | $R_{\theta JA}$ | 110 | $^\circ C/W$ |
| Thermal Resistance, Junction-to-Case ⁽¹⁾ | $R_{\theta JC}$ | 2.75 | |

Ordering Information

| Part Number | Temp. Range | Package | Packing | RoHS Status |
|-------------|-------------|---------------|---------|--------------|
| MDI5N40TH | -55~150°C | TO-251(I-PAK) | Tube | Halogen Free |
| MDD5N40RH | -55~150°C | D-PAK | Reel | Halogen Free |

Electrical Characteristics (Ta =25°C)

| Characteristics | Symbol | Test Condition | Min | Typ | Max | Unit |
|----------------------------------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | I _D = 250µA, V _{GS} = 0V | 400 | - | - | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250µA | 3.0 | - | 5.0 | |
| Drain Cut-Off Current | I _{DSS} | V _{DS} = 400V, V _{GS} = 0V | - | - | 1 | µA |
| Gate Leakage Current | I _{GSS} | V _{GS} = ±30V, V _{DS} = 0V | - | - | 100 | nA |
| Drain-Source ON Resistance | R _{D(S)ON} | V _{GS} = 10V, I _D = 1.7A | | 1.2 | 1.6 | Ω |
| Forward Transconductance | g _{fs} | V _{DS} = 30V, I _D = 1.7A | - | 2.0 | - | S |
| Dynamic Characteristics | | | | | | |
| Total Gate Charge | Q _g | V _{DS} = 320V, I _D = 3.4A, V _{GS} = 10V ⁽³⁾ | - | 9 | | |
| Gate-Source Charge | Q _{gs} | | - | 2.5 | | nC |
| Gate-Drain Charge | Q _{gd} | | - | 4 | | |
| Input Capacitance | C _{iss} | V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz | - | 290 | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 3 | | pF |
| Output Capacitance | C _{oss} | | - | 46 | | |
| Turn-On Delay Time | t _{d(on)} | V _{GS} = 10V, V _{DS} = 200V, I _D = 3.4A, R _G = 25Ω ⁽³⁾ | - | 12 | | |
| Rise Time | t _r | | - | 25 | | |
| Turn-Off Delay Time | t _{d(off)} | | - | 20 | | ns |
| Fall Time | t _f | | - | 30 | | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Maximum Continuous Drain to Source Diode Forward Current | I _S | | - | 3.4 | - | A |
| Source-Drain Diode Forward Voltage | V _{SD} | I _S = 3.4A, V _{GS} = 0V | - | | 1.4 | V |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = 3.4A, di/dt = 100A/µs | - | 200 | | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | - | 1.0 | | µC |

Note :

1. Pulse width is based on R θJC & R θJA and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width ≤300us, duty cycle≤2%, pulse width limited by junction temperature TJ(MAX)=150°C.
3. I_{SD} ≤3.4A, di/dt≤200A/us, V_{DD}=50V, R_g =25Ω, Starting TJ=25°C
4. L=26.0mH, I_{AS}=3.4A, V_{DD}=50V, R_g =25Ω, Starting TJ=25°C

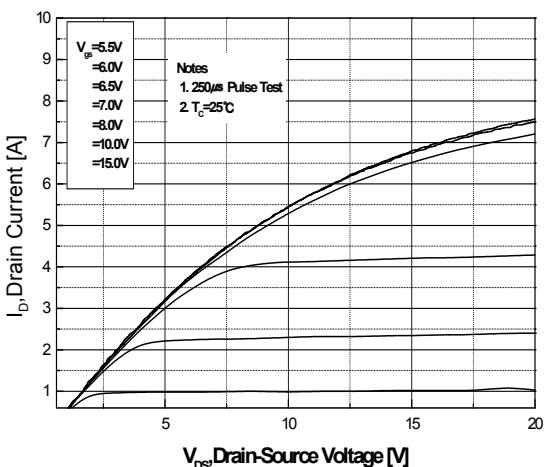


Fig.1 On-Region Characteristics

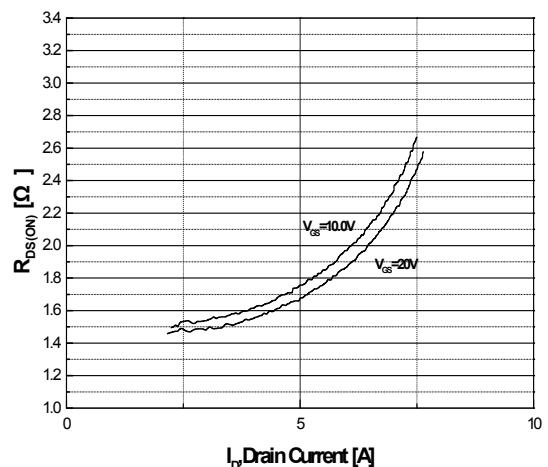


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

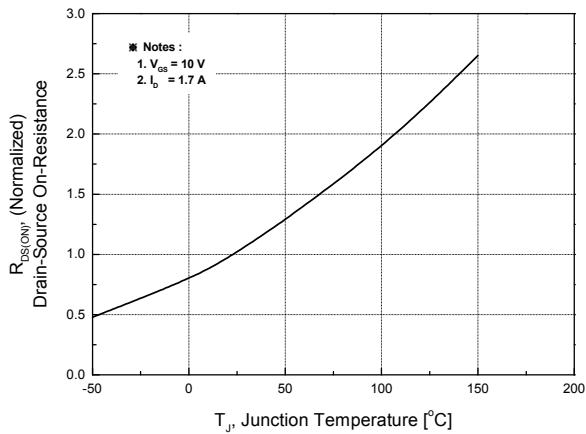


Fig.3 On-Resistance Variation with Temperature

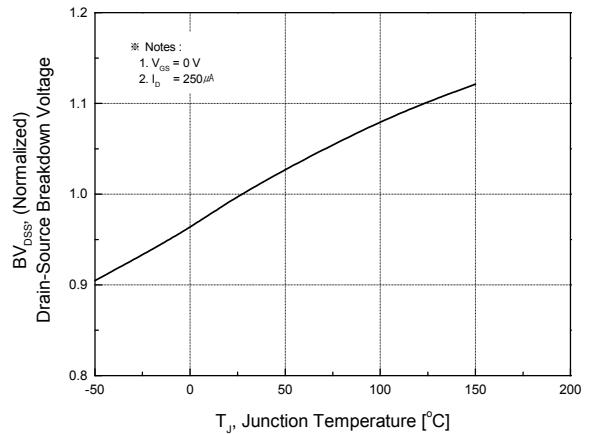


Fig.4 Breakdown Voltage Variation vs. Temperature

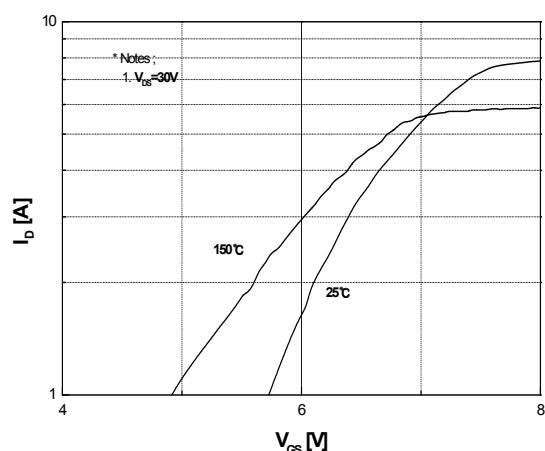


Fig.5 Transfer Characteristics

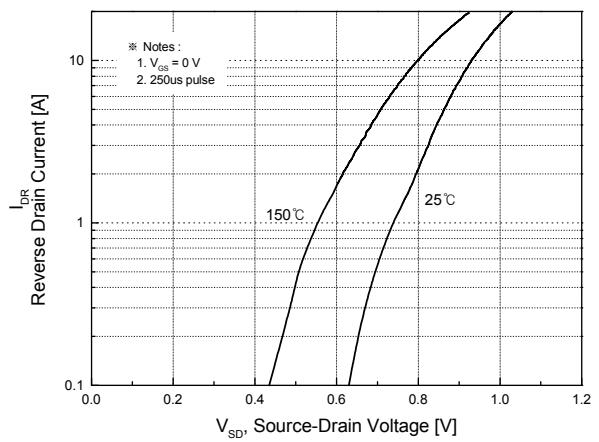
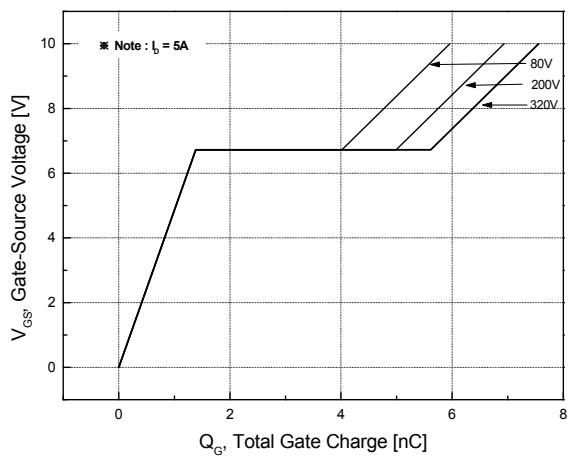
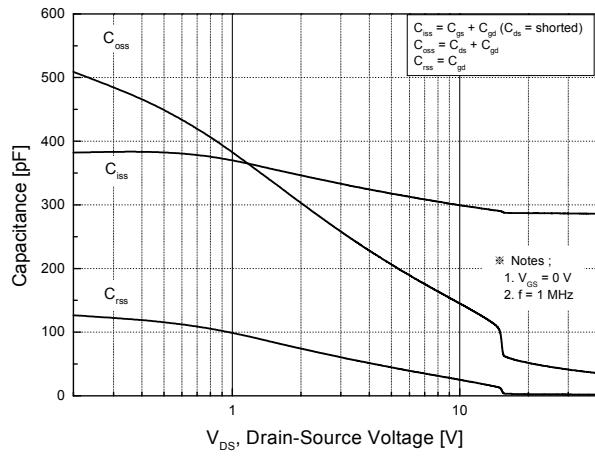
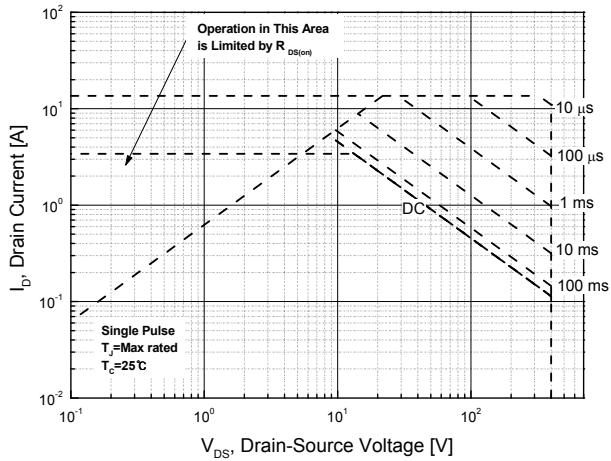
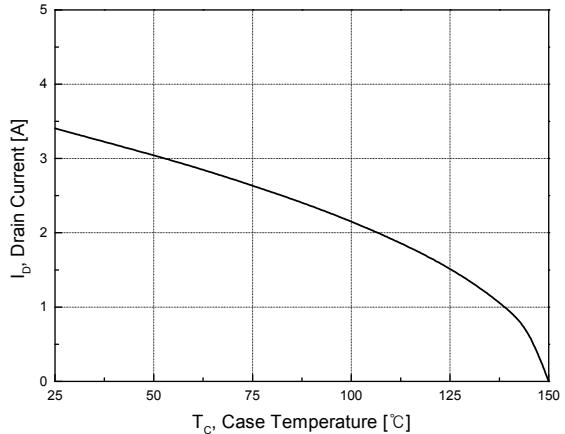
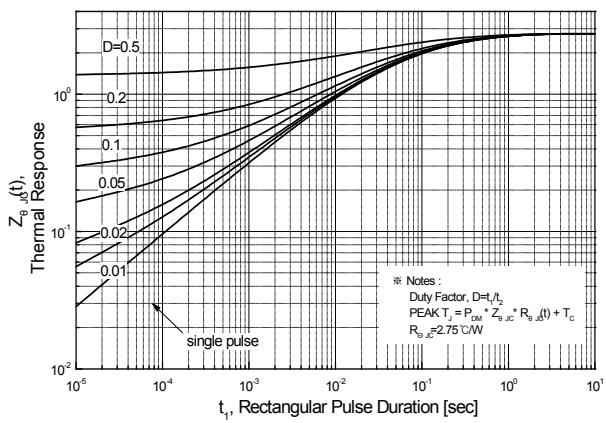
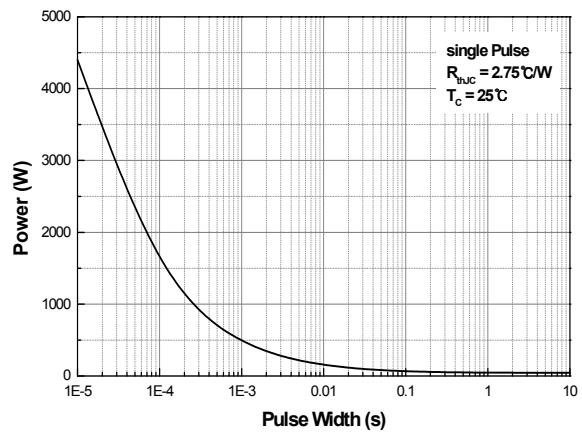


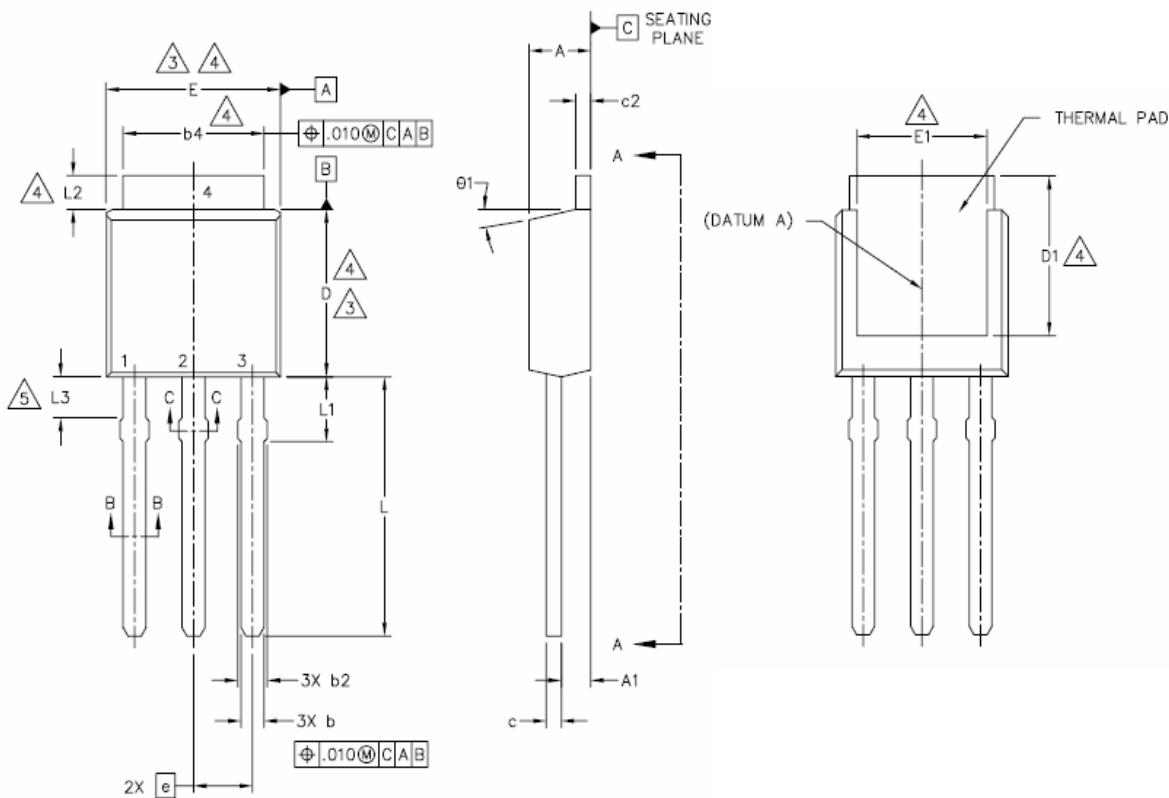
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature


Fig.7 Gate Charge Characteristics

Fig.8 Capacitance Characteristics

Fig.9 Maximum Safe Operating Area

Fig.10 Maximum Drain Current vs. Case Temperature

Fig.11 Transient Thermal Response Curve

Fig.12 Single Pulse Maximum Power Dissipation

Physical Dimension

TO-251 (I-PAK)

Dimensions are in millimeters, unless otherwise specified

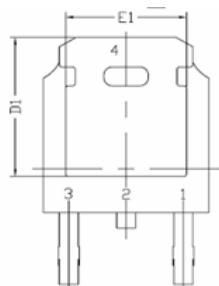
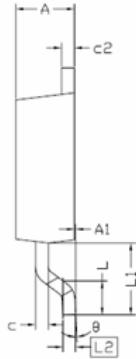
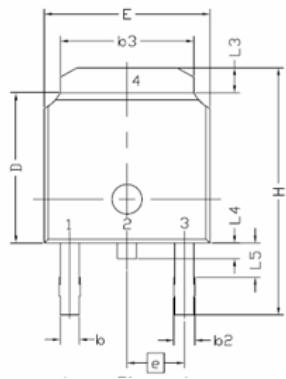


| SYMBOL | MIN | NOM | MAX |
|--------|----------|------|------|
| A | 2.18 | - | 2.39 |
| A1 | 0.89 | - | 1.14 |
| b | 0.64 | - | 0.89 |
| b1 | 0.64 | 0.71 | 0.79 |
| b2 | 0.76 | - | 1.14 |
| b4 | 4.95 | - | 5.46 |
| c | 0.46 | - | 0.61 |
| c2 | 0.46 | - | 0.89 |
| D | 5.97 | 6.10 | 6.22 |
| D1 | 4.75 | - | |
| E | 6.35 | - | 6.73 |
| E1 | 4.32 | - | 0.00 |
| e | 2.30 BSC | | |
| L | 8.89 | - | 9.65 |
| L1 | 1.80 | - | 2.29 |
| L2 | 0.70 | - | 1.27 |
| L3 | 1.14 | - | 1.52 |

Physical Dimension

D-PAK, 3L

Dimensions are in millimeters, unless otherwise specified



| Symbol | Min. | Nom. | Max. |
|--------|------|-----------|-------|
| E | 6.35 | - | 6.73 |
| L | 1.40 | 1.52 | 1.78 |
| L1 | | 2.74 REF | |
| L2 | | 0.508 BCS | |
| L3 | 0.89 | - | 1.27 |
| L4 | - | - | 1.02 |
| L5 | 1.14 | - | 1.52 |
| D | 5.97 | 6.10 | 6.22 |
| H | 9.40 | - | 10.41 |
| b | 0.64 | - | 0.89 |
| b2 | 0.76 | - | 1.14 |
| b3 | 4.95 | - | 5.46 |
| e | | 2.286 BSC | |
| A | 2.18 | - | 2.39 |
| A1 | - | - | 0.13 |
| c | 0.46 | - | 0.61 |
| c2 | 0.46 | - | 0.89 |
| D1 | 5.21 | - | - |
| E1 | 4.32 | - | - |
| θ | 0.00 | - | 10.00 |

DISCLAIMER:

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